

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Youji TAKAHASHI et al.

Serial No.: Not yet assigned

Filed: Even date herewith

For: **POWER SUPPLY, A SEMICONDUCTOR MAKING APPARATUS
AND A SEMICONDUCTOR WAFER FABRICATING METHOD USING
THE SAME**

Group: 2818

Examiner: Thao Le

**INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR §1.97 & 1.98**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

September 4, 2003

Sir:

Pursuant to 37 CFR 1.97(b) and 1.98, attached hereto is one (1) form PTO-1449 listing the four (4) references which were cited by or submitted to the U.S. Patent and Trademark Office in prior applications Serial No. 10/082,160 filed February 26, 2002, the parent application of the present continuation application.

Pursuant to 37 CFR 1.98(d), copies of these four (4) references are not being provided with this Information Disclosure Statement because the references were previously cited by or submitted to the Office in the prior applications identified above and the prior applications are being relied upon in the present application for an earlier filing date under 35 USC 120 as required by 37 CFR 1.97(d)(1), and the references which were submitted to the Office in the prior applications were

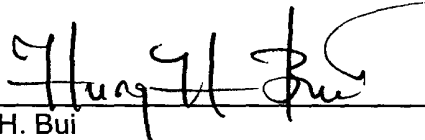
submitted in compliance with the version of 37 CFR 1.98(a)-(c) in effect as of the filing date of this Information Disclosure Statement as required by 37 CFR 1.98(d)(2).

Pursuant to 37 CFR 1.97(b)(1), this Information Disclosure Statement is being submitted within three months of the filing date of the above-identified national application.

It is respectfully requested that this Information Disclosure Statement be considered.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

A handwritten signature in black ink, appearing to read "Hung H. Bui", is written over a horizontal line.

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